Single-phase and two-phase boost converter with limp-home mode

Rev. 1 — 26 April 2018

Product data sheet

1 Introduction

The ASL1507SHN is a highly integrated and flexible one-phase DC-to-DC boost converter IC. The IC has one integrated gate driver which can drive one external power metal-oxide-semiconductor field-effect transistor (MOSFET) and two integrated proportional-integral (PI) controllers which can regulate the output voltage. It has a serial peripheral interface (SPI) allowing control and diagnostic communication with an external microcontroller.

The ASL2507SHN is a highly integrated and flexible two-phase DC-to-DC boost converter IC. The IC has two integrated gate drivers which can drive two external power metal-oxide-semiconductor field-effect transistors (MOSFETs) and two integrated proportional-integral (PI) controllers which can regulate the output voltage on both channels. It has a serial peripheral interface (SPI) allowing control and diagnostic communication with an external microcontroller.

The ASL1507SHN; ASL2507SHN is designed primarily for use in automotive LED lighting applications and provides an optimized supply voltage for ASLx416/17SHN multichannel LED buck driver.

For simplicity, the data sheet states always 'gate drivers' and 'output voltages'. The ASL1507SHN has only one gate driver and can only drive one output.

2 General description

The ASL1507SHN; ASL2507SHN has a fixed frequency peak current mode control with parabolic/non-linear slope compensation. It can operate with input voltages from 5.5 V to 40 V. It can be configured in boost topology via SPI for output voltages of up to 80 V, to power the LED buck driver IC.

The ASL1507SHN is a single-phase boost converter with one output voltage. The ASL2507SHN is a two-phase boost converter, which can have two independent outputs. The ASL2507SHN is configurable via the SPI interface, as a single output converter with either one phase or two phases, or two independent output voltages. In case the SPI communication is lost in an abnormal situation, it switches to limp-home mode operation ensuring system safety.

The ASL1507SHN; ASL2507SHN boost converter can drive up to two external low-side N channel MOSFETs from an internally regulated adjustable supply. It can drive either logic or standard level MOSFETs.

The integrated SPI interface also allows for programming the supply under/overvoltage range, output voltage range, frequency spread spectrum, and DC-to-DC switching frequency. It enables the optimization of external components and flexibility for electromagnetic compatibility (EMC) design. This interface can be used also to provide diagnostic information such as the device temperature, battery voltage, VGG voltage, output voltage etc.



Single-phase and two-phase boost converter with limp-home mode

The ASL1507SHN; ASL2507SHN integrates a non-volatile memory (NVM) to save the default configuration internally. The configuration includes boost ramp-up, boost voltage, frequency setting, error detection and etc. The default configuration is used in limp-home mode (SPI fail) and autonomous mode (no MCU). Additional features include input undervoltage lockout and thermal shutdown when the junction temperature of the ASL1507SHN; ASL2507SHN exceeds $T_{sd(otp)}$.

The device is housed in a very small HVQFN32 package with an exposed thermal pad. It is designed to meet the stringent requirements of automotive applications. It is fully AEC-Q100 grade 1 qualified. It operates over the -40 °C to +125 °C ambient automotive temperature range.

3 Features and benefits

- AEC-Q100 grade 1 qualified
- · Limp-home mode ensuring system safety
- Up to two flexible output voltages with 3 % accuracy programmable via SPI
- · Single phase on each output or double phase on one output
- Fixed frequency operation via built-in oscillator from 125 kHz to 700 kHz
- · Slope compensation to track the frequency and output voltage
- Programmable control loop compensation
- Programmable spread spectrum functionality
- · Gate switching is halted when overvoltage on output is detected
- Programmable gate voltage
- Low electromagnetic emission (EME) and high electromagnetic immunity (EMI)
- Output voltage monitoring
- Supply voltage measurement
- Control signal to enable the device low quiescent current < 5 µA when EN = 0
- · Read-back programmed voltage and frequency range via SPI
- · Junction temperature monitoring via SPI
- Small package outline HVQFN32
- Wide operating input voltage range from +5.5 V to +40 V
- Operating ambient temperature range of -40 °C to +125 °C

4 Applications

- Automotive LED lighting
 - Daytime running lights
 - Position or park light
 - Low beam
 - High beam
 - Turn indicator
 - Fog light
 - Cornering light

5 Ordering information

Table 1. Ordering information						
Type Package						
number	Name	Description	Version			
ASL1507SHN	HVQFN32	plastic thermal enhanced very thin quad flat package; no leads; 32 terminals; body 5 \times 5 \times 0.85 mm	SOT617-12			
ASL2507SHN	HVQFN32	plastic thermal enhanced very thin quad flat package; no leads; 32 terminals; body 5 \times 5 \times 0.85 mm	SOT617-12			

6 Block diagram



NXP Semiconductors

ASL1507SHN; ASL2507SHN

Single-phase and two-phase boost converter with limp-home mode



Single-phase and two-phase boost converter with limp-home mode

7 Pinning information

7.1 Pinning





ASL1507_ASL2507
Product data sheet

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Single-phase and two-phase boost converter with limp-home mode

7.2 Pin description

Table 2.	Pin d	escription	

Symbol		Pin	Description
ASL1507SHN	ASL2507SHN		
SNL1	SNL1	1	phase 1 sense low
SNH1	SNH1	2	phase 1 sense high
GND	GND	3	ground
G1	G1	4	phase 1 gate driver
VGG	VGG	5	gate driver supply
n.c. ^[1]	-	6	not connected
-	G2	6	phase 2 gate driver
GND	GND	7	ground
n.c. ^[1]	-	8	not connected
-	SNH2	8	phase 2 sense high
n.c. ^[1]	-	9	not connected
-	SNL2	9	phase 2 sense low
n.c. ^[1]	n.c. ^[1]	10	not connected
FB1 ^[2]	FB1 ^[2]	11	feedback, output 1
n.c. ^[1]	n.c. ^[1]	12	not connected
VBAT	VBAT	13	battery supply
n.c. ^[1]	n.c. ^[1]	14	not connected
n.c. ^[1]	-	15	not connected
-	FB2 ^[2]	15	feedback, output 2
n.c. ^[1]	n.c. ^[1]	16	not connected
n.c. ^[1]	n.c. ^[1]	17	not connected
i.c. ^[3]	i.c. ^[3]	18	internally connected
n.c. ^[1]	n.c. ^[1]	19	not connected
n.c. ^[1]	n.c. ^[1]	20	not connected
n.c. ^[1]	n.c. ^[1]	21	not connected
n.c. ^[1]	n.c. ^[1]	22	not connected
n.c. ^[1]	n.c. ^[1]	23	not connected
i.c. ^[3]	i.c. ^[3]	24	internally connected
n.c. ^[1]	n.c. ^[1]	25	not connected
SDI	SDI	26	SPI data input
SCLK	SCLK	27	SPI clock
CSB	CSB	28	SPI chip select
EN	EN	29	enable signal

ASL1507_ASL2507
Product data sheet

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Single-phase and two-phase boost converter with limp-home mode

Symbol	Symbol		Description	
ASL1507SHN	ASL2507SHN			
VCC	VCC	30	external 5 V supply	
SDO	SDO	31	SPI data output	
GND	GND	32	chip ground	

Not connected pins are internally not connected and can be left floating or can be connected to any voltage level. [1]

See Figure 6 and Figure 19 for recommend connections for pin FB1 and FB2.

[2] [3] Internally connected pins should be connected to GND.

For enhanced thermal and electrical performance, the exposed center pad of the package should be soldered to board ground (and not to any other voltage level).

Functional description 8

8.1 Operating modes



Single-phase and two-phase boost converter with limp-home mode

Table 3. Operating modes

Mode	Control registers	Configuration registers	Diagnostic IC registers	VGG	V ₀₁ V ₀₂	Remark
Reset	n.a.	n.a.	n.a.	off	off	device is off, no communication possible
Configuration	read/write	read/write	read	off	off	VGG is off if the output was not previously enabled
				according to register	off	VGG stays on as soon as the output has been enabled
Operation	read/write	read	read	locked	according to register	configuration register is locked
Fail silent	read/write	read ^[1]	read	off	off	communication possible, but the output is off; restart via EN possible
Standby	read/write	read/write	read	according to register	off	
Limp-home mode	read	read	read	according to NVM settings	according to NVM settings	operating per NVM settings
NVM access	read/write	read/write	read	off	off	NVM read/write possible

[1] Setting the bit CFG_DN to logic 0 also grants write access to the configuration registers.

Table 4. Operation mode register (address 56h)

Bit	Symbol	Description	Value	Function
7 to 3	STATE[4:0]	operation mode of the device	0 0100	configuration mode
			1 0101	operation mode
			1 0111	standby mode
			1 1011	NVM access mode
			1 1100 1 1101 1 1110 0 1011	fail silent mode
			others	internal states used during state transitions
2 to 0	internal	internally used	-	-

8.1.1 Reset mode

The ASL1507SHN; ASL2507SHN switches to reset mode, if the input voltage drops below the power-on detection threshold voltage $V_{th(det)pon}$ or the pin EN is LOW.

The SPI interface and output are turned off when the ASL1507SHN; ASL2507SHN is in the reset mode.

8.1.2 Configuration mode

The ASL1507SHN; ASL2507SHN switches from reset mode to configuration mode, as soon as the input voltage is above the power-on detection threshold voltage $V_{th(det)pon}$ and pin EN is HIGH.

The configuration registers can be set when the ASL1507SHN; ASL2507SHN is in the configuration mode.

8.1.3 Standby mode

The ASL1507SHN; ASL2507SHN switches from operation to standby mode when bit CFG_DN is set to logic 0 while bit AUTO is set to logic 0 as well. In standby mode V_{O1} and V_{O2} are turned off while VGG remains on.

8.1.4 Operation mode

The ASL1507SHN; ASL2507SHN switches from configuration mode to operation mode, as soon as the configuration done bit is set. Once the bit is set to logic 1, the configuration registers are locked and cannot be changed.

In operation mode, the output is available as configured via the SPI interface. Setting the bit VO1EN or VO2EN, starts up VGG. Once VGG is in regulation (signaled by bit VGG_OK), the output voltages V_{O1} and V_{O2} are turned on accordingly. When the converters are on, the battery monitoring functionality is available.

8.1.5 Fail silent mode

The ASL1507SHN; ASL2507SHN switches from operation, configuration, standby, or limp-home mode to fail silent mode, when the junction temperature exceeds the overtemperature shutdown threshold or a VGG error is detected. It also switches modes when the input voltage is below the undervoltage detection threshold or above the overvoltage detection threshold.

In fail silent mode, all outputs are turned off and only the SPI interface remains operational.

8.1.6 Limp-home mode

The ASL1507SHN; ASL2507SHN limp-home mode is activated by detecting loss of SPI communication. In limp-home mode, the outputs are operating according to predefined conditions in an NVM; see <u>Section 8.12</u> for more information.

During limp-home mode operation, the SPI interface remains functional but only the limp-home mode control register can be written. The other registers offer only read access.

8.1.7 NVM access mode

The ASL1507SHN; ASL2507SHN switches from configuration mode to NVM access mode when the NVM access mode entry command is given. In NVM access mode, the NVM settings can be defined and read back.

Single-phase and two-phase boost converter with limp-home mode

8.2 Boost converter configuration

The ASL1507SHN; ASL2507SHN is an automatic boost converter IC delivering constant DC-to-DC voltage to a load. It has a fixed frequency current-mode control for an enhanced stable operation.

The ASL2507SHN offers two phases. Each phase consists of a coil, a resistor, a MOSFET and a diode as shown in Figure 6.



To allow a flexible use of the ASL1507SHN; ASL2507SHN, the configuration is based on virtual phases, which are then mapped to a real. That is, physical phase according to the physical connections and conditions of the circuitry around the ASL1507SHN; ASL2507SHN as shown in Figure 7.



8.2.1 Configuration of the virtual phases

The ASL2507SHN can generate up to two internal phases for up to two virtual outputs. With the internal phase control enable registers, it can be selected, how many virtual phases are generated for the individual virtual outputs.

Single-phase and two-phase boost converter with limp-home mode

Bit	Symbol	Description	Value	Function
7	SS_WIDTH1[1:0]	spread spectrum width for	-	refer to Section 8.4
6		logic 1		
5	SS_SCEN1[1:0]	SS scenario for logic 1	-	refer to Section 8.4
4				
3	EN_P4_1	phase 4 enabled	0	phase 4 is off
			1	phase 4 is enabled
2	EN_P3_1	phase 3 enabled	0	phase 3 is off
			1	phase 3 is enabled
1	EN_P2_1	phase 2 enabled	0	phase 2 is off
			1	phase 2 is enabled
0	EN_P1_1	phase 1 enabled	0	phase 1 is off
			1	phase 1 is enabled

Table 5. SS scenario logic 1 (address 0Bh)

Table 6. SS scenario logic 2 (address 0Ch)

Bit	Symbol	Description	Value	Function
7	SS_WIDTH2[1:0]	spread spectrum width for	-	refer to Section 8.4
6		logic 2		
5	SS_SCEN2[1:0]	SS scenario for logic 2	-	refer to Section 8.4
4				
3	EN_P4_2	phase 4 enabled	0	phase 4 is off
			1	phase 4 is enabled
2	EN_P3_2	phase 3 enabled	0	phase 3 is off
			1	phase 3 is enabled
1	EN_P2_2	phase 2 enabled	0	phase 2 is off
			1	phase 2 is enabled
0	EN_P1_2	phase 1 enabled	0	phase 1 is off
			1	phase 1 is enabled

8.2.2 Association of gate drivers to the output voltages

Each phase that the ASL2507SHN offers must be associated to one of the outputs. Multiple combinations are possible. For example, all phases to one of the outputs, or one phase to one output and one phase to another one.

Single-phase and two-phase boost converter with limp-home mode

Table 7. Gate unver output (address 021)				
Bit	Symbol	Description	Value	Function
7 to 2	reserved	reserved	000000	reserved; should remain clear for future use
1	O_G2	J	0	gate driver 2 is connected to V_{O1}
	driver 2	driver 2	1	gate driver 2 is connected to V_{O2}
0	O_G1	association gate driver 1	0	gate driver 1 is connected to V_{O1}
			1	gate driver 1 is connected to V_{O2}

Table 7. Gate driver output (address 02h)

8.2.3 Association of gate drivers to the internal phase generation

The gate drivers that the ASL1507SHN; ASL2507SHN offer must be associated to one of the internal virtual logics. It is established with the gate driver phase and phase select configuration registers. Internal logic 1 and logic 2 include four phases, which are used connecting to physical gate driver.

Tuble c	Table o. Gate unver phase (address of it)				
Bit	Symbol	Description	Value	Function	
7 to 2	reserved	reserved	000000	reserved; should remain clear for future use	
1	O_GP2	O_GP2 association gate driver 2	0	gate driver 2 is connected to logic 1	
			1	gate driver 2 is connected to logic 2	
0	O_GP1	association gate	0	gate driver 1 is connected to logic 1	
		driver 1	1	gate driver 1 is connected to logic 2	

Table 8. Gate driver phase (address 0Fh)

Table 9. Phase select configuration (address 10h)

Bit	Symbol	Description	Value	Function
7 to 4	reserved	reserved	0000	reserved; should remain clear for future use
3 and 2	PHSEL2[1:0]	phase select	00	routing from phase 1
		gate driver 2	01	routing from phase 2
			10	routing from phase 3
			11	routing from phase 4
1 and 0	PHSEL1[1:0]	phase select	00	routing from phase 1
		gate driver 1	01	routing from phase 2
			10	routing from phase 3
			11	routing from phase 4

8.2.4 Enabling of connected phases

The gate driver enable register is used to configure which of the phases is active.

Single-phase and two-phase boost converter with limp-home mode

I able 1	Table 10. Gate driver enable (address 01n)					
Bit	Symbol	Description	Value	Function		
7 to 2	reserved	reserved	000000	reserved; should remain clear for future use		
1 ^[1]	EN_G2	phase 2 enabled	0	phase 2 is off		
			1	phase 2 is enabled		
0	EN_G1	phase 1 enabled	0	phase 1 is off		
	-		1	phase 1 is enabled		

able 40. Oate duiver exchile (address 04b)

[1] For the ASL1507SHN, this bit is reserved.

8.2.5 Configuration of the boost converter frequencies

The operation frequency of the boost converters is set via several SPI registers. To ensure a stable phase delay between the different phases, all timings are derived from the same oscillator. An integer number downscales the internal oscillator frequency for each regulation loop. The slower clock controls the off-time of a phase and the delay from one phase of the regulation loop to the next internal phase. The number of phases determinates finally when the phase is turned on again and so defines the operation frequency of the boost converter.



Table 11. Clock divider for V_{O1} (address 09h)

Bit	Symbol	Description	Value	Function
7 to 0	CLKDIV1[7:0]	clock divider for	00h	clock is not divided
		output voltage 1		clock is divided by CLKDIV1[7:0] + 1
			FFh	clock is divided by 256

NXP Semiconductors

ASL1507SHN; ASL2507SHN

Single-phase and two-phase boost converter with limp-home mode

Table 12. Clock divider for V_{O2} (address 0Ah)

Bit	Symbol	Description	Value	Function
7 to 0	CLKDIV2[7:0]	clock divider for output voltage 2	00h	clock is not divided
				clock is divided by CLKDIV2[7:0] + 1
			FFh	clock is divided by 256

Table 13. Phase-off time and phase delay of output 1 (address 0Dh)

Bit	Symbol	Description	Value	Function
7 to 3	PHDEL1[4:0]	delay to next phase of	00h	phase delay is one clock period of the divided clock
		output 1		phase delay is PHDEL1[4:0] + one clock period of the divided clock
		1Fh	phase delay is 32 clock periods of the divided clock	
2 to 0	PHOFF1[2:0]	PHOFF1[2:0] phase-off time of output 1	00h	phase-off time is one clock period of the divided clock
				phase-off time is PHOFF1[2:0] of the divided clock
			07h	phase-off time is seven clock periods of the divided clock

Table 14. Phase-off time and phase delay of output 2 (address 0Eh)

Bit	Symbol	Description	Value	Function
7 to 3	PHDEL2[4:0]	delay to next phase of	00h	phase delay is one clock period of the divided clock
		output 2		phase delay is PHDEL2[4:0] + one clock period of the divided clock
		1Fh	phase delay is 32 clock periods of the divided clock	
2 to 0	PHOFF2[2:0]	2[2:0] phase-off time of output 2	00h	phase-off time is one clock period of the divided clock
				phase-off time is PHOFF2[2:0] of the divided clock
		07h	phase-off time is seven clock periods of the divided clock	

Remark: To obtain the best performance of the internal slope compensation, keep the possible settings of the delay between the phases close to 32.

8.2.6 Control loop parameter setting

The ASL1507SHN; ASL2507SHN is able to operate with a wide range of external components and offers wide range of operating frequencies. To achieve the maximum performance for each set of operation conditions, set the control loop parameters according to the external components and the operating frequency.

Table 13. Loop men proportional comgutation (address 111)					
Bit	Symbol	Description	Value	Function	
7 to 4		0h	proportional factor output 2 is 0.05		
		output 2		proportional factor output 2 is PROP2[3:0] × 0.05 + 0.05	
			Fh	proportional factor output 2 is 0.8	
3 to 0	PROP1[3:0]	proportional factor	0h	proportional factor output 1 is 0.05	
		output 1		proportional factor output 1 is PROP1[3:0] × 0.05 + 0.05	
			Fh	proportional factor output 1 is 0.8	

Table 15. Loop filter proportional configuration (address 11h)

Table 16. Loop filter integral configuration (address 12h)

Bit	Symbol	Description	Value	Function
7 to 4	INTEG2[3:0]	integral factor output 2	0h	integral factor output 2 is 0.005
				integral factor output 2 is INTEG2[3:0] × 0.005 + 0.005
			Fh	integral factor output 2 is 0.08
3 to 0	INTEG1[3:0]	integral factor output 1	0h	integral factor output 1 is 0.005
			integral factor output 1 is INTEG1[3:0] × 0.005 + 0.005	
			Fh	integral factor output 1 is 0.08

Table 17. Slope compensation configuration (address 13h)

Bit	Symbol	Description	Value	Function
7 to 4	SLPCMP2[3:0]	slope compensation factor	0h	slope compensation factor output 2 = 112 k Ω
		output 2	1h	slope compensation factor output 2 = 84 k Ω
			2h	slope compensation factor output 2 = 70 k Ω
		4h	slope compensation factor output 2 = 56 k Ω	
			8h	slope compensation factor output 2 = 28 k Ω
3 to 0	SLPCMP1[3:0]	slope compensation factor	0h	slope compensation factor output 1 = 112 k Ω
		output 1	1h	slope compensation factor output 1 = 84 k Ω
			2h	slope compensation factor output 1 = 70 k Ω
			4h	slope compensation factor output 1 = 56 k Ω
			8h	slope compensation factor output 1 = 28 k Ω

ASL1507_ASL2507
Product data sheet

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Single-phase and two-phase boost converter with limp-home mode

Bit	Symbol	Description	Value	Function
7 to 4	reserved	reserved	-	
3 and 2	SLPR2[1:0]	slope resistor	0h	250 Ω
	configuration for gate	configuration for gate driver 2	1h	500 Ω
			2h	1000 Ω
			3h	1500 Ω
1 and 0	SLPR1[1:0]	slope resistor configuration for gate driver 1	0h	250 Ω
			1h	500 Ω
			2h	1000 Ω
			3h	1500 Ω

ant course clans resister configuration (address 44b) his 40 Cum

8.3 Output voltage programmability

The ASL1507SHN; ASL2507SHN provides the possibility to program the output voltage and output overvoltage protection of the output via the SPI interface.

8.3.1 Output voltage target programming

The target output voltage can be programmed via the output voltage registers. As the ASL1507SHN; ASL2507SHN is a boost converter, the output voltage cannot be lower than the supply voltage minus the drop of the converter diode (Dx in Figure 6).

Table 19. Output voltage 1 register (address 03h)

Bit	Symbol	Description	Value	Function
7 to 0	V_VO1[7:0]	target voltage output 1	00h	output 1 is turned off
				target voltage output 1 = 0.3606 V × V_VO1[7:0]
			FFh	maximum target output voltage = 90 V

Table 20. Output voltage 2 register (address 04h)

Bit	Symbol	Description	Value	Function
7 to 0	V_VO2[7:0]	target voltage output 2	00h	output 2 is turned off
				target voltage output 2 = 0.3606 V × V_VO2[7:0]
			FFh	maximum target output voltage = 90 V

8.3.2 Output overvoltage protection programming

Due to fast changes in the supply or the output, disruption is possible in the output voltage. To avoid high voltages damaging the attached components, the ASL1507SHN; ASL2507SHN offers a programmable overvoltage protection threshold. Once the output voltage is above this threshold, the gate pin of the output stops toggling. It results in a halt of the energy delivery to the output.

Once the output voltage recovers and is below the threshold again, the gate pin starts toggling again. The regulation loop regulates the output back to the target value.

For stable operation of the device, the limit voltage output register should be programmed higher than the corresponding output voltage registers. The limit voltage output setting should be chosen to allow the regulation loop to operate continuously in case of overshoots due to load changes.

Table 2	Table 21. Limit voltage output 1 register (address 05h)					
Bit	Symbol	Description	Value	Function		
7 to 0	VMAX_VO1[7:0]	limit output 1	00h	output 1 is turned off		
				output overvoltage protection output 1 = 0.3606 V × VMAX_VO1[7:0]		
			FFh	maximum output overvoltage protection output 1 = 90 V		

Table 22. Limit voltage output 2 register (address 06h)

Bit	Symbol	Description	Value	Function
7 to 0	VMAX_VO2[7:0]	limit output 2	00h	output 2 is turned off
				output overvoltage protection output 2 = 0.3606 V × VMAX_VO2[7:0]
			FFh	maximum output overvoltage protection output 2 = 90 V

8.3.3 Output voltage ramp up

Output voltage ramp up is a feature which ramps up the target voltage. Timing and step size can be programmed.

Bit	Symbol	Description	Value	Function
7 and 6	reserved	reserved	-	
5	RAMP1	ramp up select	0	ramp up enabled
			1	ramp up disabled
4 to 2	STEP_T1[2:0]	step time for V _{O1}	000	40 µs
			001	80 µs
			010	160 µs
			011	320 µs
			100	520 µs
			101	1040 µs
			110	2040 µs
			111	4040 µs
1 and 0	STEP_V1[1:0]	step size for V _{O1}	00	0.7 V
			01	1.4 V
			10	2.8 V
			11	5.6 V

Table 23. Ramp up output 1 (address 1Fh)

Single-phase and two-phase boost converter with limp-home mode

Table 24	Table 24. Ramp up output 2 (address 20h)							
Bit	Symbol	Description	Value	Function				
7 and 6	reserved	reserved	-					
5	RAMP2	ramp up select	0	ramp up enabled				
			1	ramp up disabled				
4 to 2	STEP_T2[2:0]	step time for $V_{\rm O2}$	000	40 µs				
			001	80 µs				
			010	160 µs				
			011	320 µs				
			100	520 µs				
			101	1040 µs				
			110	2040 µs				
			111	4040 µs				
1 and 0	STEP_V2[1:0]	step size for V_{O2}	00	0.7 V				
			01	1.4 V				
			10	2.8 V				
			11	5.6 V				

8.3.4 Dead-band setting

The regulation loop of the output voltage of the ASL1507SHN; ASL2507SHN uses a selectable dead-band. A higher dead-band setting results into higher noise level on the output, but fewer regulation adjustments thus a more smooth regulation. This setting is part of the internal register 5 (address 30h). The content of this register can only be changed in configuration mode.

Bit	Symbol	Description	Value	Function
7 and 6	reserved	reserved	-	
5 and 4	DEAD_BAND[1:0]	dead-band setting	00	180 mV
			01	350 mV
			10	700 mV
			11	1.4 V
3 to 0	internal	internally used	9h	no modification allowed

Table 25. Internal register 5 (address 30h)

8.4 Frequency spread spectrum

The frequency spread spectrum achieves clock dithering, on-chip technique for EMI reduction. Slope clock division factor is changed dynamically based on spread spectrum ramp profiles (triangular ramp) or using a PRBS (random) generator. The frequencies used by the system during spread spectrum operation can be calculated with the following formula.

Single-phase and two-phase boost converter with limp-home mode

$$f_{sw(used)} = \frac{f_{osc(int)}}{\frac{f_{osc(int)}}{f_{sw(set)}} + x}$$

(1)

 $f_{\text{sw}(\text{used})}$ is the used switching frequency of the system without spread spectrum enabled.

 $f_{sw(set)}$ is the set switching frequency.

 $f_{\mbox{osc(int)}}$ is the internal oscillator frequency.

x is according to <u>Table 29</u> and <u>Table 30</u>.

Table 26. Spread spectrum enable register (address 1Ch)

Bit	Symbol	Description	Value	Function
7	reserved	reserved	-	
6	internal	internally used	0	internally used; must remain logic 0
5	RESTART_TEMP	restart after TEMP error	1	restart after power down due to TEMP error condition, once TEMP error gets cleared
			0	no restart in case of TEMP error
4	·····	restart after VBAT error	1	restart after power down due to VBAT UV/OV error condition, once VBAT UV/OV error gets cleared
			0	no restart in case of VBAT UV/OV error
3	EN_PRBS_CH2_	enable the spread	0	disable; ramp profile active
	SPREAD_SPECTRUM	spectrum scenario	1	enable; random profile active
2	EN_CH2_SPREAD_		0	disable
	SPECTRUM		1	enable
1	EN_PRBS_CH1_	-	0	disable; ramp profile active
	SPREAD_SPECTRUM		1	enable; random profile active
0	EN_CH1_SPREAD_		0	disable
	SPECTRUM		1	enable

Table 27. SS scenario logic 1 register (address 0Bh)

Bit	Symbol	Description	Value	Function
7 and 6	SS_WIDTH1[1:0]	spread spectrum width for logic 1	-	see <u>Table 29</u> and <u>Table 30</u>
5 and 4	SS_SCEN1[1:0]	SS scenario for logic 1	-	see <u>Table 29</u> and <u>Table 30</u>
3	EN_P4_1	phase 4 enabled	-	see Table 5
2	EN_P3_1	phase 3 enabled	-	see Table 5
1	EN_P2_1	phase 2 enabled	-	see Table 5
0	EN_P1_1	phase 1 enabled	-	see Table 5

Single-phase and two-phase boost converter with limp-home mode

Bit	Symbol	Description	Value	Function
7 and 6	SS_WIDTH2[1:0]	spread spectrum width for logic 2	-	see <u>Table 29</u> and <u>Table 30</u>
5 and 4	SS_SCEN2[1:0]	SS scenario for logic 2	-	see <u>Table 29</u> and <u>Table 30</u>
3	EN_P4_2	phase 4 enabled	-	see Table 6
2	EN_P3_2	phase 3 enabled	-	see Table 6
1	EN_P2_2	phase 2 enabled	-	see Table 6
0	EN_P1_2	phase 1 enabled	-	see <u>Table 6</u>

Table 29. Ramp profile

SS_SCENx[1:0]	SS_WIDTHx[1:0]							
	00	01	10	11				
00 01	0 to 255 and 255 to 0	0 to 127 and 127 to 0	0 to 63 and 63 to 0	0 to 31 and 31 to 0				
10	−256 to 0 and 0 to −256	−128 to 0 and 0 to −128	-64 to 0 and 0 to -64	-32 to 0 and 0 to -32				
11	-128 to +127 and +127 to -128	-64 to +63 and +63 to -64	−32 to +31 and +31 to −32	−16 to +15 and +15 to −16				

Table 30. Random profile

SS_SCENx[1:0] S			SS_WIDTHx[1:0]		
	00	01	10	11	
00 01	0 to 255	0 to 127	0 to 63	0 to 31	
10	−128 to −1	−64 to −1	-32 to -1	−16 to −1	
11	-128 to +127	-64 to +63	-32 to +31	-16 to +15	

8.5 Coil peak current limitation

The ASL1507SHN; ASL2507SHN offers a function to limit peak current inside the coil and therefore to limit the input current for the system. Furthermore, this functionality can be used to avoid magnetic saturation of the coils. It also allows some soft start feature to be realized with this function.

With the maximum phase current V_{Ox} register, the maximum peak current for the phase can be configured. Once the voltage between pins SNLx and SNHx achieves maximum level, the gate will be turned off until the next switching cycle. To avoid subharmonic oscillations when the coil peak current limitation is becoming active, the slope compensation remains active. It reduces the coil peak current toward the end of the switching cycle to ensure stable operation of the system.

In order to avoid that this function interferes with the normal regulation, the limit should be placed well above the maximum expected current.

Bit	Symbol	Description	Value	Function
7 to 0		00h	no current allowed	
		limitation assigned to V _{O1}		maximum peak current = (IMAX1[7:0] × 1.8 V / 256 – 0.24 V) / R_{sense}
		80h	maximum allowed setting = (128 / 255 × 1.8 V – 0.24 V) / R_{sense}	
				not allowed
			FFh	not allowed

Table 31. Maximum coil current V_{O1} register (address 07h)

Table 32. Maximum coil current V_{O2} register (address 08h)

Bit	Symbol	Description	Value	Function
7 to 0		00h	no current allowed	
		limitation assigned to V _{O2}		maximum peak current = (IMAX2[7:0] × 1.8 V / 256 – 0.24 V) / R_{sense}
		80h	maximum allowed setting = (128 / 255 × 1.8 V – 0.24 V) / R_{sense}	
				not allowed
			FFh	not allowed

8.6 Enabling the output voltage

The ASL1507SHN; ASL2507SHN provides two independent output voltages. In operation mode, the output voltages are turned on with the bit VO1EN and VO2EN.

As soon as one of the outputs is turned on, the VGG voltage regulator is turned on. After $t_{startup}$ the gate drivers start switching, provided the bit VGG_OK is set.

ASL1507_ASL2507
Product data sheet

Single-phase and two-phase boost converter with limp-home mode

i able 33.	Table 33. Function control register (address 00h)					
Bit	Symbol	Description	Value	Function		
7	reserved	reserved	n.a.	reserved; should remain cleared for future use		
6	EN_VBAT_	enable VBAT	0	disabled		
MEASUREMENT	measurement	1	VBAT measurement is available before starting the converter			
5 and 4	internal	internally used	00	internally used; must remain 00		
3	3 CNT_CSB count chip s time	count chip select	0	chip select low count feature is disabled		
		time	1	chip select low count feature is enabled		
2	VO2EN	enable output 2	0	output 2 is turned off		
			1	output 2 is turned on when the device is in operation mode		
1	VO1EN	enable output 1	0	output 1 is turned off		
			1	output 1 is turned on when the device is in operation mode		
0	CFG_DN	configuration done bit	0	device is in configuration mode; no configuration lock		
			1	device is in operation mode; configuration lock is active		

Table 33. Function control register (address 00h)

8.7 Gate voltage supply

The ASL1507SHN; ASL2507SHN has an integrated linear regulator to generate the supply voltage of the gate drivers. The integrated linear regulator is internally connected to the pin VGG. The voltage generated by the linear regulator can be set via the VGG control register.

Table 34. VGG control register (address 15h); bit 4 in NVM address 00h register is set to logic 0

Bit	Symbol	Description	Value	Function
7 to 0	VGG[7:0]	supply voltage for	00h	not allowed
		gate drivers		not allowed
			80h	maximum output voltage = 7.98 V
				16.07 - 0.0632 × VGG[7:0]
			B7h	minimum output voltage = 4.50 V
				not allowed
			FFh	not allowed

NXP Semiconductors

ASL1507SHN; ASL2507SHN

Single-phase and two-phase boost converter with limp-home mode

Bit	Symbol	Description	Value	Function
7 to 0	gate drivers	not allowed		
		not allowed		
	5Dh		5Dh	maximum output voltage = 10.19 V
		16.07 – 0.0632 × VGG[7:0]		
			B7h	minimum output voltage = 4.50 V
				not allowed
			FFh	not allowed

Table 35. VGG control register (address 15h); bit 4 in NVM address 00h register is set to logic 1

If a setting between FFh and B7h is used, the device may not start up VGG. If the device operates, parameters of VGG are not guaranteed.

8.7.1 Gate voltage supply diagnostics

The diagnostic options for the gate voltage supply are:

- VGG available; details can be found in <u>Section 8.10</u>
- VGG protection active; details can be found in <u>Section 8.10</u>

8.8 Supply voltage monitoring

The ASL1507SHN; ASL2507SHN continuously measures the voltage at pin VBAT. It allows the system to monitor the supply voltage without additional external components. It also offers the option to put an automatic undervoltage/overvoltage protection in place.

8.8.1 Battery voltage measurement

The ASL1507SHN; ASL2507SHN continuously measures the voltage at pin VBAT. The measurement result is available in the battery voltage register when the output is enabled or when bit 6 in SPI register 00h is set to logic 1.

Bit	Symbol	Description	Value	Function
7 to 0	V_VBAT[7:0]	battery voltage	00h	battery voltage = 0 V
				battery voltage = 0.3606 V × V_VBAT[7:0]
			FFh	maximum measurable battery voltage = 90 V

8.8.2 Undervoltage detection

The ASL1507SHN; ASL2507SHN offers a variable undervoltage detection threshold. When the supply voltage drops below this threshold, the undervoltage detect bit is set and the gate pin stops toggling and no more power is delivered to the output.

Table 37. Undervoltage threshold register (address 1Bh)

Bit	Symbol	Description	Value	Function	
7 to 0	V_VBAT_UV[7:0]	•	00h	undervoltage detection threshold = 0 V	
		detection threshold		undervoltage detection threshold = $0.3606 \text{ V} \times \text{V}_{VBAT}_{UV}$	
			FFh	maximum undervoltage detection threshold = 90 V	

8.8.3 Overvoltage detection

The ASL1507SHN; ASL2507SHN offers a variable overvoltage detection threshold. When the supply voltage rises above this threshold, the overvoltage detect bit is set and fail silent mode is entered. The gate pin stops toggling and no power is delivered to the output.

Table 38. Overvoltage threshold register (address 1Ah)

Bit	Symbol	Description	Value	Function
7 to 0	V_VBAT_OV[7:0]	J	00h	overvoltage detection threshold = 0 V
		detection threshold		overvoltage detection threshold = 0.3606 V × V_VBAT_OV[7:0]
			FFh	maximum overvoltage detection threshold = 90 V

8.9 Junction temperature information

The ASL1507SHN; ASL2507SHN provides a measurement of the IC junction temperature. The measurement information is available in the junction temperature register.

 Table 39. Junction temperature register (address 46h)

Bit	Symbol	Description	Value	Function
7 to 0	o 0 T_JUNCTION[7:0] junction temperature 0		00h to 17h	device junction temperature below −40 °C
			18h	device junction temperature = −40 °C
	-			device junction temperature = T_JUNCTION[7:0] × (215 / 106) °C - 88 °C
			82h	device junction temperature = 175 °C
			83h to FFh	device junction temperature above 175 °C

Table 40 Discussofis register (address CCb)

ASL1507SHN; ASL2507SHN

Single-phase and two-phase boost converter with limp-home mode

8.10 Diagnostic information

The diagnostic register contains useful information for diagnostic purposes. Details for each bit can be found in the following subsections.

Bit	Symbol	Description	Value	Function
7	VO1_OK	V _{O1} regulated	0	V _{O1} is deviating from the target value
			1	V _{O1} is regulated to the target value
6	VO2_OK	V _{O2} regulated	0	V_{O2} is deviating from the target value
			1	V _{O2} is regulated to the target value
5	VGG_OK	VGG regulation OK	0	VGG is not available
			1	VGG is available
4	TJ_ERR	device temperature is too high	0	device temperature below T _{sd(otp)}
			1	device temperature above T _{sd(otp)}
3	VBAT_UV	VBAT undervoltage	0	no undervoltage at VBAT detected
			1	undervoltage at VBAT detected
2	VBAT_OV	VBAT overvoltage	0	no overvoltage at VBAT detected
			1	overvoltage at VBAT detected
1	SPI_ERR	SPI error	0	last SPI command was executed correctly
			1	last SPI command was erroneous and has been discarded
0	VGG_ERR	VGG error	0	VGG protection not active
			1	VGG protection has turned on and VGG is deactivated

8.10.1 Bit VBAT_OV

The bit VBAT_OV depends on the battery monitoring functionality as described in <u>Section 8.8.3</u>. It indicates that the device has detected an overvoltage condition and enables an option to select the auto recover or fail silent mode.

A write access to the diagnostic register or entering off mode, clears the bit. Independent of the clearing of the bit, the device stays in fail silent mode.

8.10.2 Bit VBAT_UV

The bit VBAT_UV depends on the battery monitoring functionality as described in <u>Section 8.8.2</u>. It indicates that the device has detected an undervoltage condition.

A write access to the diagnostic register or entering off mode, clears the bit. Independent of the clearing of the bit, the device stays in fail silent mode.

8.10.3 Bit SPI_ERR

The device evaluates all SPI accesses to the device for the correctness of the commands. When the command is not allowed, the SPI_ERR bit is set.

A write access to the diagnostic register or entering off mode, clears the bit.

8.10.4 Bit TJ_ERR

The bit TJ_ERR indicates that the junction temperature has exceeded the maximum allowable temperature and the device has entered fail silent mode.

A write access to the diagnostic register or entering off mode, clears the bit. Independent of the clearing of the bit, the device stays in fail silent mode.

8.10.5 Bit VGG_ERR

The bit VGG_ERR is set when the gate voltage did not reach the VGG_OK window (when $V_{drv(G)VGG_OK}$ is within the range) within $t_{startup}$. Once bit VGG_ERR is set, it indicates that an error on the gate voltage regulator has been detected and the device has entered fail silent mode. A write access to the diagnostic register clears the VGG_ERR bit. The device stays in fail silent mode irrespective of the clearing of the bit.

8.10.6 Bit VGG_OK

The bit VGG_OK indicates that the gate driver voltage is regulated to the target voltage and allows the gate drivers to drive the gate driver pins.

If the gate driver voltage is outside the VGG_OK window ($V_{reg(VGG_OK)}$) after $t_{startup}$, the device clears the VGG_OK bit and the device enters fail silent mode.

8.10.7 Bits VO1_OK and VO2_OK

The bits VO1_OK and VO2_OK indicate whether the output voltage is regulated to the target value. The bits are set as soon as the corresponding output voltage is $V_{O(VO_OK)}$ for more than $t_{fltr(Vo)}$. The bits are cleared when the corresponding output is not equal to $V_{O(VO_OK)}$ for more than $t_{fltr(Vo)}$.

8.11 Restart on error

In case the ASL1507SHN; ASL2507SHN enters fail silent mode, it switches off the outputs.

In default mode, the EN pin must be cycled and the ASL1507SHN; ASL2507SHN should be reconfigured to start operation. In another mode of operation, ASL1507SHN; ASL2507SHN can be configured which does not require the EN pin cycling. In this mode, when the error condition is resolved, the state machine automatically exits the fail silent mode. The operation restarts as configured prior to entering the fail silent mode. This auto restart mode can be controlled through NVM by programming the bits.

Restart can be independently done for TJ_ERR, VBAT_UV and VBAT_OV conditions; refer to <u>Section 8.4</u>.

8.12 Limp-home mode

In case of detection of a loss of SPI communication, the ASL1507SHN; ASL2507SHN enters limp-home mode. In limp-home mode, ASL1507SHN; ASL2507SHN operates according to predefined conditions stored in an NVM.

The settings with which the device operates in limp-home settings can be configured in NVM use mode. In NVM use mode, the outputs are disabled. After configuration, the limp-home settings will be permanently stored if not changed. Once the ASL1507SHN; ASL2507SHN detects a loss of SPI communication in normal operation, the device populates these settings into the registers and operates according to them.

In case the system recovers from the error, limp-home mode can be left via the exit limp-home mode sequence. With the completion of the exit sequence, the device operates according to the SPI register.

Limp-home offer the same operational features as normal operation.

Bit 3 in register 54h indicates the limp-home mode status of the device.

Bit	Symbol	Description	Value	Function
7 to 4	internal	internally used	-	-
3	LHM	HM limp-home mode indication		device is in limp-home mode
			0	device is not in limp-home mode
2 to 0	internal	internally used	-	-

Table 41. Limp-home mode indication (address 54h)

8.12.1 Limp-home mode activation

The limp-home mode can be enabled and disabled in end-user application with the LIMP_DIS bit (bit 2 of the multi-content NVM data field). Once enabled the ASL1507SHN; ASL2507SHN is expecting a write command to the limp-home mode control register (address 3Ch) with the bits LIMP_EXIT[2:0] all set to logic 1. The write command refreshes the LH_TIMER. In case the LH_TIMER it not refreshed before it expires, the device enters into limp-home mode.

Refer to <u>Section 8.13.1</u> for more information on starting the NVM write sequence.

8.12.2 Limp-home mode operation

Once the system enters to limp-home mode, the ASL1507SHN; ASL2507SHN switches to the configuration as defined in the NVM memory for limp-home mode. The ASL1507SHN; ASL2507SHN modifies the control registers accordingly.

During limp-home mode operation, the SPI interface remains functional, but only the limp-home mode control register can be written. The other registers offer only read access.



8.12.3 Limp-home mode deactivation

To deactivate limp-home mode, a dedicated limp-home mode deactivation sequence must be written to the limp-home mode control register (address 3Ch).

Table 42. Limp-home mode deactivation sequence

Deactivation step	Data to LIMP_EXIT[2:0]	
Step 1	001	
Step 2	010	
Step 3	100	
Limp-home refresh	111	

Once the deactivation sequence is completed, the ASL1507SHN; ASL2507SHN immediately starts to react on SPI communication. The registers remain as set for the limp-home mode. Once the system is back to operation mode, all registers are accessible as defined for operation mode again.

8.12.4 Limp-home mode control register

The limp-home mode control register allows control of the limp-home mode.

Bit	Symbol	Description	Value	Function
7	reserved			n.a.
6 to 4	LIMP_EXIT[2:0]	limp-home mode deactivation sequence		limp-home mode deactivation and refresh pattern; see <u>Table 42</u>
3 to 1	3 to 1 LH_TIMER[2:0] limp-home timeout		000	5.4096 ms
			001	10.8192 ms
			010	21.6396 ms
			011	43.2792 ms
			100	86.5584 ms
		101	173.1168 ms	
		110	346.2336 ms	
			111	692.4792 ms
0	reserved			n.a.

Table 43. Limp-home mode control register (address 30

8.13 NVM memory

The ASL1507SHN; ASL2507SHN features an internal error correction module to ensure reliable operation of the NVM memory. All required ECC codes can be internally generated and in case of errors the corrections are done automatically.

Bit	Symbol	Description	Value	Function
7	EEB	disables ECC block for write operation	0	must be kept logic 0
6	ECB	disables ECC block for read operation	0	must be kept logic 0
5 to 0	NVM_WRITE_ECC[5:0]	-	00000	error correction code for NVM write data; not used when bit EEB is logic 0

Single-phase and two-phase boost converter with limp-home mode

Bit	Symbol	Description Value Fund		Function
7 to 4	internal	internally used	-	-
3 and 2	NVM_MODE[1:0]	enter and exit NVM program mode	01	enter NVM access mode
			10	exit NVM access mode
			others	invalid; no action
1 and 0	NVM_ACCESS[1:0]	initiate NVM read/write commands	00 changes to 01	initiate NVM read ^[1]
			00 changes to 10	initiate NVM write ^[1]
			others	invalid; no action

Table 45. NVM control register (address 3Ah)

[1] NVM accesss is only executed when NVM_DONE is set to logic 1.

Table 46. NVM status register (address 55h)

Bit	Symbol	Description	Value	Function	
7 to 5	internal	internally used	-	-	
4	NVM_ACCESS	customer NVM	0	not possible	
		access possible	1	possible when in NVM access mode	
3	ILLEGAL_NVM	illegal NVM access	0	not happened	
			1	at least one illegal NVM access happened	
2 and 1	internal	internally used	-	-	
0	NVM_DONE	NVM action	0	NVM action in progress	
		complete	1	NVM action completed	

8.13.1 NVM write sequence

To write an NVM register, the device must be in NVM access mode. The following sequence should be used.

- Check that the ASL1507SHN; ASL2507SHN is in configuration mode (register 56h shows binary 0010 0XXXb) and limp-home mode is not active (register 54h shows binary XXXX X0XXb).
- 2. Enter NVM access mode by setting register 3Ah to 04h.
- Confirm that the ASL1507SHN; ASL2507SHN is in NVM access mode (register 56h shows binary 1101 1XXXb).
- 4. Write target NVM address to NVM address register (register 36h is target register).
- 5. Write target NVM_DATA[15:8] into data register 37h.
- 6. Write target NVM_DATA[7:0] into data register 38h.
- 7. Ensure that the ECC is calculated internally (register 39h = 00h).
- 8. Ensure that the NVM is ready (register 55h shows binary XXXX XXX1b).
- 9. Initiate NVM write:
 - Write register 3Ah with XXXX 0100b.
 - Write register 3Ah with XXXX 0110b.

10.Wait until NVM access is completed (register 55h shows binary XXXX XXX1b).

11.If further NVM access is required, start at step four of the read or write sequence.

12.Exit NVM access mode by setting register 3Ah to 08h.

13.NVM access complete; for reset set pin EN = LOW.

Note:

The IC is only considering the NVM content programmed as valid when bit 1 and bit 0 in the NVM register 00h indicate 10b. The IC is allowing 200 write cycles to the NVM. The number for write counts can be stored in the NVM write counter in NVM address 01h. This counter should be increased after each update.

NXP Semiconductors

ASL1507SHN; ASL2507SHN

Single-phase and two-phase boost converter with limp-home mode



ASL1507_ASL2507
Product data sheet

8.13.2 NVM read sequence

To read an NVM register, the device must be in NVM access mode. The following sequence should be used.

- Check that the ASL1507SHN; ASL2507SHN is in configuration mode (register 56h shows binary 0010 0XXXb) and limp-home mode is not active (register 54h shows binary XXXX X0XXb).
- 2. Enter NVM access mode by setting register 3Ah to 04h.
- Confirm that the ASL1507SHN; ASL2507SHN is in NVM access mode (register 56h shows binary 1101 1XXXb).
- 4. Write target NVM address to NVM address register (register 36h is target register).
- 5. Ensure that the NVM is ready (register 55h shows binary XXXX XXX1b).
- 6. Initiate NVM read:
 - Write register 3Ah with XXXX 0100b.
 - Write register 3Ah with XXXX 0101b.
- 7. Wait until NVM access is completed (register 55h shows binary XXXX XXX1b).
- 8. Data from the NVM is now available in NVM data read register 59h for NVM_DATA[15:8] and register 5Ah for NVM_DATA[7:0].
- 9. If further NVM access is required, start at step four of the read or write sequence.
- 10.Exit NVM access mode by setting register 3Ah to 08h.
- 11.NVM access complete; for reset set pin EN = LOW.

NXP Semiconductors

ASL1507SHN; ASL2507SHN

Single-phase and two-phase boost converter with limp-home mode



Single-phase and two-phase boost converter with limp-home mode

8.13.3 NVM register map

The ASL1507SHN; ASL2507SHN allows limp-home values during NVM access. <u>Table 47</u> shows the linking of the NVM addresses to the register addresses.

Table 47. Mapping of NVM registers to control registers

NVM address linked to SPI register 36h[4:0]	NVM_DATA[15:8] linked to SPI register 37h and 59h	NVM_DATA[7:0] linked to SPI register 38h and 5Ah
00h	n.a.	multi-content NVM data fields
01h	NVM write count bit 15 to bit 8	NVM write count bit 7 to bit 0
02h	n.a.	function control
03h	n.a.	gate driver enable
04h	gate driver output	output voltage 1
05h	output voltage 2	limit voltage output 1
06h	limit voltage output 2	maximum coil current V _{O1}
07h	maximum coil current V_{O2}	clock divider for V_{O1}
08h	clock divider for V_{O2}	SS scenario logic 1
09h	SS scenario logic 2	phase-off time and phase delay of output 1
0Ah	phase-off time and phase delay of output 2	gate driver phase
0Bh	phase select configuration	loop filter proportional configuration
0Ch	loop filter integral configuration	slope compensation configuration
0Dh	current sense slope resistor configuration	VGG control
0Eh	internal 1	overvoltage threshold
0Fh	undervoltage threshold	spread spectrum enable
10h	internal 2	internal 3
11h	internal 4	internal 5
12h	ramp up output 1	ramp up output 2

The NVM data fields that contain more than just one register are shown in Table 48.

NVM address	Name	7	6	5	4	3	2	1	0
00h					enable VGG voltage range to 16 V	AUTO	LIMP_DIS	customer write pattern to indic programmed: 00 is not programmed (interna 01 is programmed 10 is programmed 11 is not programmed (interna	al defaults are used)

Table 48. Overview of multi-content NVM data field

Single-phase and two-phase boost converter with limp-home mode

8.14 Autonomous mode

Autonomous mode enables the chip to load the configuration from NVM and start conversion as soon as EN is HIGH without waiting for SPI configuration from MCU or detection of SPI communication timeout.



Table 49. Comparison of limp-home mode and autonomous mode

Mode	Condition	IC operation	SPI	Exit
Limp-home	the watchdog timer detects an SPI communication error	the state machine goes through power-down sequence and then copies the NVM configuration to the SPI registers to resume the operation but with the NVM setting	only access to the limp-home mode control register	microcontroller has to write the unlock pattern to the register
Autonomous	if bit AUTO is set to logic 1 in NVM	the state machine copies the required settings from NVM into the SPI registers along with the CFG_DN bit to start the converter	microcontroller less operation, default no SPI communication needed, if auto and limp-home are enabled at the same time, startup in autonomous mode	power down, reset the bit AUTO

8.14.1 Limp-home mode/autonomous mode NVM

<u>Table 50</u> summarizes the NVM programming options for both limp-home and autonomous modes.

Table 50. NVM programming options						
NVM address 00h	Feature					
LIMP_DIS = 1; AUTO = 0	no limp-home and no autonomous					
LIMP_DIS = 0; AUTO = 0	limp-home mode enabled (in case of limp-home timeout, the system applies settings from NVM)					
LIMP_DIS = 1; AUTO = 1	autonomous mode enabled					
LIMP_DIS = 0; AUTO = 1	startup immediately with autonomous mode; limp-home mode enabled					

Table 50 NVM programming options
8.15 SPI

The ASL1507SHN; ASL2507SHN uses an SPI interface to communicate with an external microcontroller. The SPI interface can be used for setting the output voltage, reading and writing the control register.

8.15.1 SPI introduction

The SPI provides the communication link with the microcontroller, supporting multi-slave operations. The SPI is configured for full duplex data transfer, so status information is returned when new control data is shifted in. The interface also offers a read-only access option, allowing the application to read back the registers without changing the register content.

The SPI uses four interface signals for synchronization and data transfer:

- CSB SPI chip select: active LOW
- · SCLK SPI clock: default level is LOW due to low-power concept
- SDI SPI data input
- · SDO SPI data output: floating when pin CSB is HIGH

Bit sampling is performed on the falling clock edge and data is shifted on the rising clock edge as illustrated in <u>Figure 13</u>.



The data bits of the ASL1507SHN; ASL2507SHN are arranged in registers of 1 byte length. Each register is assigned to a 7-bit address. For writing into a register, 2 bytes must be sent to the LED driver.

The first byte is an identifier byte that consists of the 7-bit address and one read-only bit. For writing, the read-only bit must be set to logic 0. The second byte is the data that is written into the register. So an SPI access consists of at least 16 bit.

Figure 14 together with <u>Table 51</u> and <u>Table 52</u> demonstrates the SPI frame format.

Single-phase and two-phase boost converter with limp-home mode



Table 51. SPI f	frame format	for a trans	sition to	the device
-----------------	--------------	-------------	-----------	------------

Bit	Symbol	Description	Value	Function
15	B15	R/W bit	0	write access
			1	read access
14 to 8	B[14:8]	address bits	XXX XXXX	selected address
7 to 0	B[7:0]	data bits	XXXX XXXX	transmitted data

Table 52. SPI frame format for a transition from the device^[1]

Bit	Symbol	Description	Value	Function
15 to 8	B[15:8]	diagnostic register 1	XXXX XXXX	content of diagnostic register 1
7 to 0	B[7:0]	data bits	XXXX XXXX	when previous command was a valid read command, content of the register that is supposed to be read
			XXXX XXXX	when previous command was a valid write command, new content of the register that was supposed to be written

[1] The first SPI command after leaving the off mode returns 00h.

The master initiates the command sequence. The sequence begins with CSB pin pulled LOW and lasts until it is asserted HIGH.

The ASL1507SHN; ASL2507SHN also tolerates SPI accesses with a multiple of 16 bits. It allows a daisy chain configuration of the SPI.

ASL1507SHN; ASL2507SHN

Single-phase and two-phase boost converter with limp-home mode





During the SPI data transfer, the identifier byte and the actual content of the addressed registers is returned via the SDO pin. The same happens for pure read accesses. Here the read-only bit must be set to logic 1. The content of the data bytes that are transmitted to the ASL1507SHN; ASL2507SHN is ignored.

The ASL1507SHN; ASL2507SHN monitors the number of data bits that are transmitted. If the number is not 16, or a multiple of 16, then a write access is ignored and the SPI error indication bit is set.

Single-phase and two-phase boost converter with limp-home mode

8.15.2 Typical use case illustration (write/read)

Consider a daisy chain scheme with one master connected to four slaves in daisy chain fashion. The following commands are performed during one sequence (first sequence).

- · Write data FFh to register 1Ah of slave 1
- Read from register 2h of slave 2
- Write data AFh to register 2Fh of slave 3
- Read from register 44h of slave 4



8.15.3 Diagnostics for the SPI interface

The device is evaluating all SPI access to the device for the correctness of the commands. When the command is not allowed, the SPI_ERR bit is set. The conditions that are considered as erratic accesses are:

- · SPI write is attempted to a read-only location or reserved location
- · SPI write is attempted during operation to a configuration register
- SPI read is attempted from a reserved location
- · SPI command does not consist of a multiple of 16 clock counts

If an SPI access is considered to be erratic, no modifications to an SPI register are made. The access after the erratic SPI command returns for bit 15 to bit 8 the content of the diagnostic register, and for bit 7 to bit 0 as 00h.

For details about the SPI_ERR bit, see <u>Section 8.10.3</u>.

Single-phase and two-phase boost converter with limp-home mode

8.15.4 Register map

8.15.4.1 Control registers

Table 53 provides an overview of the control registers and their reset value.

Single-phase and two-phase boost converter with limp-home mode

Address	Name	Reset value	7	6	5	4	3	2	1	0
00h	function control	00h	reserved	EN_VBAT_ MEASUREMENT	-	-	CNT_CSB	VO2EN ^[1]	VO1EN ^[1]	CFG_DN
01h	gate driver enable	00h			reserv	ved			EN_G2 ^[2]	EN_G1 ^[2]
03h	output voltage 1	00h				V_V01	[7:0]		I	1
04h	output voltage 2	00h		V_VO2[7:0]						
05h	limit voltage output 1	00h		VMAX_VO1[7:0]						
06h	limit voltage output 2	00h				VMAX_V	O2[7:0]			
07h	maximum coil current V _{O1}	46h				IMAX1	[7:0]			
08h	maximum coil current V _{O2}	46h				IMAX2	[7:0]			
1Ch	spread spectrum enable	09h				refer to Se	ction 8.4			
1Fh	ramp up output 1	00h	res	served	RAMP1		STEP_T1[2:0]		STEP	V1[1:0]
20h	ramp up output 2	00h	res	served	RAMP2		STEP_T2[2:0]		STEP_	V2[1:0]
3Ch	limp-home mode control		reserved	L	IMP_EXIT[2:0]]		LH_TIMER[2:0]]	reserved

Table 53. Control register group overview

[1] Bit is locked with bit CFG_DN = 1. When bit CFG_DN = 0, bits can be changed. Read is always possible.

[2] With the gate driver enable bits, the individual gate drivers that were enabled when CFG_DN and VGG_OK were set to logic 1, can be turned on and off during operation of the system. The gate drivers that are disabled, when the CFG_DN and VGG_OK are set to logic 1, are off, even when the bits are set to logic 1 later.

8.15.4.2 Configuration registers

<u>Table 54</u> provides an overview of the configuration registers. The configuration registers inside the control block can only be written in configuration mode. In the other modes, this register can only be read.

Address	Name	Reset value	7	6	5	4	3	2	1	0	
02h	gate driver output	00h			re	eserved	1	1	O_G2	0_G1	
09h	clock divider for V _{O1}	0Fh				C	CLKDIV1[7:0	0]	1		
0Ah	clock divider for V_{O2}	0Fh				C	CLKDIV2[7:0)]			
0Bh	SS scenario logic 1	0Fh	SS_ SS_ WIDTH1[1:0] SCEN1[1:0]		EN_P4_1	EN_P3_1	EN_P2_1	EN_P1_1			
0Ch	SS scenario logic 2	0Fh		S_ H2[1:0]		S_ I2[1:0]	EN_P4_2	EN_P3_2	EN_P2_2	EN_P1_2	
0Dh	phase-off time and phase delay of output 1	39h	PHDEL1[4:0]				F	PHOFF1[2:0)]		
0Eh	phase-off time and phase delay of output 2	39h	PHDEL2[4:0]			PHOFF2[2:0]					
0Fh	gate driver phase	00h	reserved					O_GP2	O_GP1		
10h	phase selection configuration	E4h	reserved			PHSE	_2[1:0] PHSEL1[1:0]		L1[1:0]		
11h	loop filter proportional configuration	00h	PROP2[3:0]				PROP1[3:0]				
12h	loop filter integral configuration	00h		INTEG	2[3:0]			INTEG1[3:0]			
13h	slope compensation configuration	88h		SLPCM	P2[3:0]			SLPCMP1[3:0]			
14h	current sense slope resistor configuration	00h		resei	rved		SLPF	2[1:0]	SLPR	1[1:0]	
15h	VGG control	FFh					VGG[7:0]		1		
1Ah	overvoltage threshold	FFh				V_	VBAT_OV[7	7:0]			
1Bh	undervoltage threshold	00h				V_	VBAT_UV[7	7:0]			
36h	NVM address	00h	rese	erved	a	address	for NVM dat	a to be writ	ten or read[5:0]	
37h	NVM data MSB	00h				NVM w	rite data M	SB byte			
38h	NVM data LSB	00h				NVM v	vrite data LS	B byte			
39h	ECC code	00h	EEB[7]	ECB[7]			NVM_W	RITE_ECC[5:0]		
3Ah	NVM control	00h		inter	nal		NVM_M	ODE[1:0]	NVM_AC	CESS[1:0]	

Table 54	Configuration	register	aroun	overview
	oomiguration	register	group	Over view

Single-phase and two-phase boost converter with limp-home mode

8.15.4.3 Internal registers

The ASL1507SHN; ASL2507SHN uses the SPI registers to control some internal functions. In order to avoid any unintended behavior of the device, do not modify these registers but leave them all at their default value.

Address	Name	Reset value	7	6	5	4	3	2	1	0
19h	internal 1	82h	-	-	-	-	-	-	-	-
25h	internal 2	27h	-	-	-	-	-	-	-	-
26h	internal 3	3Bh	-	-	-	-	-	-	-	-
2Fh	internal 4	E8h	-	-	-	-	-	-	-	-
30h	internal 5	09h	-	-	-	-	-	-	-	-

Table 55 Internal register overview

8.15.4.4 Diagnostic registers

Table 56. Diagnostic register group overview

Address	Name	7	6	5	4	3	2	1	0
41h	CSB count LOW				CSB_C	NT[7:0]			
42h	CSB count HIGH				CSB_CI	VT[15:8]			
45h	battery voltage				V_VBA	AT[7:0]			
46h	junction temperature		T_JUNCTION[7:0]						
54h	limp-home mode indication	internal LHM inte					internal		
55h	NVM status register	internal			NVM_ ACCESS	ILLEGAL_ NVM	internal		NVM_ DONE
56h	operation mode register			STATE[4:0]			internal	
59h	NVM data MSB			N	VM read da	ata MSB byte	9		
5Ah	NVM data LSB		NVM read data LSB byte						
5Fh	diagnostic register	VO1_OK	VO2_OK	VGG_OK	TJ_ERR	VBAT_ UV	VBAT_ OV	SPI_ERR	VGG_ ERR

Limiting values 9

Table 57. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{BAT}	battery supply voltage	EN = LOW	-0.3	+60	V
		EN = HIGH	-0.3	+40	V
V _{VCC}	voltage on pin VCC		-0.3	+5.5	V
V _{GND}	ground supply voltage	voltage between ground pins	-0.6	+0.6	V
V _{fbck}	feedback voltage	pins FB1 and FB2	-0.3	+80	V
Vo	output voltage	in accordance with register 03h and 04h	10	80	V
V _{IO}	input/output voltage	pins SDO, SDI, CSB, SCLK and EN	-0.3	+5.5	V
V _{VGG}	voltage on pin VGG		-0.3	+20	V
	sense voltage	pins SNL1 and SNL2	-0.3	+0.3	V
		pins SNH1 and SNH2	-0.3	+1.8	V
V _G	gate voltage	pins G1 and G2	-0.3	+10	V
V _x	voltage on pin x	internally connected pins	-0.3	+1.8	V
Tj	junction temperature		-40	+175	°C
		during programming of NVM	0	80	°C
T _{stg}	storage temperature		-55	+175	°C
V _{ESD}	electrostatic discharge voltage	НВМ	^[1] –2	+2	kV
		CDM	[2] -500	+500	V

[1] [2]

Human Body Model (HBM): according to AEC-Q100-002 (100 pF, $1.5 \text{ k}\Omega$). Charged Device Model (CDM): according to AEC-Q100-011 (field induced charge; 4 pF).

10 Thermal characteristics

Table 58. 1	Thermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	HVQFN32 package JEDEC [1]	37	K/W

According to JEDEC JESD51-2, JESD51-5 and JESD51-7 at natural convection on 2s2p board. Board with two inner copper layers (thickness: 35 µm) [1] and thermal via array under the exposed pad connected to the first inner copper layer.

Single-phase and two-phase boost converter with limp-home mode

11 Static characteristics

Table 59. Static characteristics

Minimum and maximum values are specified for the following conditions: $V_{VBAT} = 4.5 V$ to 40 V, $V_{EN} = 4.5 V$ to 5.5 V, $V_{VCC} = 4.5 V$ to 5.5 V and $T_j = -40 °C$ to +175 °C. All voltages are defined regarding ground, positive currents flow into the IC. Typical values are given at $V_{VBAT} = 40 V$, $V_{EN} = 5 V$, $V_{VCC} = 5 V$ and $T_j = 25 °C$; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Supply pin VB	AT	1		I		
I _{BAT}	battery supply current	operating; no load on VGG; gate pins LOW; one phase; one output	5	13	-	mA
		operating; no load on VGG; gate pins LOW	-	20	-	mA
l _{off}	off-state current	EN = LOW	-	-	5	μA
V _{th(det)pon}	power-on detection threshold voltage		-	-	4.5	V
Supply pin VC	C	1]
I _{VCC}	supply current on pin VCC	operating	-	-	250	μA
Pin EN		1				
I _{EN}	current on pin EN	operating	-	-	225	μA
Output voltage	;					
V _{O(acc)}	output voltage accuracy	deviation from target set value for V_{O1}	-0.03 × V ₀₁ - 0.721	-	+0.03 × V _{O1} + 0.721	V
		deviation from target set value for $V_{\rm O2}$	-0.03 × V _{O2} - 0.721	-	+0.03 × V _{O2} + 0.721	V
V _{reg(VO)VO_OK}	VO_OK output voltage regulator voltage	bits VO1_OK and VO2_OK are set when V_{O1} and V_{O2} are within the range regarding the target value	-5.4	-	+2.4	V
VGG output ch	naracteristics		- ·	·		
V _{reg}	regulator voltage	$V_{BAT} \ge V_{reg} + V_{do(reg)}$	4.46	-	10.04	V
V _{do(reg)}	regulator dropout voltage	I _{reg} ≤ 50 mA; regulator in saturation	-	0.5	1.0	V
		I _{reg} ≤ 160 mA; regulator in saturation	-	1.6	3.2	V
V _{reg(acc)}	regulator voltage accuracy	25 °C to T _{j(max)}	-5	-	+5	%
		−40 °C to +25 °C	-7	-	+5	%
V _{reg(VGG_OK)}	VGG_OK regulator voltage	bit VGG_OK is set when VGG is within the range regarding the target value	-	2.4	-	V

ASL1507SHN; ASL2507SHN

Single-phase and two-phase boost converter with limp-home mode

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Serial periph	neral interface inputs; pins SDI, S	SCLK, and CSB				
V _{th(sw)}	switching threshold voltage		0.3 × V _{VCC}	-	$0.7 \times V_{VCC}$	V
R _{pd(int)}	internal pull-down	on pin SCLK	40	-	80	kΩ
	resistance	on pin CSB	40	-	80	kΩ
		on pin SDI	40	-	80	kΩ
Serial periph	neral interface data output; pin S	DO				
V _{OH}	HIGH-level output voltage	I _{OH} = -4 mA; V _{VCC} = 4.5 V to 5.5 V	V _{VCC} – 0.4	-	-	V
V _{OL}	LOW-level output voltage	I _{OL} = 4 mA; V _{VCC} = 4.5 V to 5.5 V	-	-	0.4	V
I _{LOZ}	OFF-state output leakage current	$V_{CSB} = V_{VCC};$ $V_O = 0 V to V_{VCC}$	-5	-	+5	μA
Temperature	e protection	I		_		
T _{sd(otp)}	overtemperature protection shutdown temperature		150	175	200	°C
ΔT _j	junction temperature variation	T _j = 130 °C	-20	-	+20	°C
VBAT monite	oring	1				
V _{BAT(acc)}	battery supply voltage accuracy		-0.035 × V _{BAT} - 0.3606	-	+0.035 × V _{BAT} + 0.3606	V

12 Dynamic characteristics

Table 60. Dynamic characteristics

Minimum and maximum values are specified for the following conditions: $V_{VBAT} = 4.5 V$ to 40 V, $V_{EN} = 4.5 V$ to 5.5 V, $V_{VCC} = 4.5 V$ to 5.5 V and $T_j = -40 \degree$ C to +175 °C. All voltages are defined regarding ground, positive currents flow into the IC. Typical values are given at $V_{VBAT} = 40 V$, $V_{EN} = 5 V$, $V_{VCC} = 5 V$ and $T_j = 25 \degree$ C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f _{DCDC}	DC-to-DC converter frequency		125	-	700	kHz
f _{DCDC(acc)}	DC-to-DC converter frequency accuracy	operating; trimmed	-5	-	+5	%
t _{startup}	start-up time	for SPI read and write	-	-	150	μs
f _{osc(int)}	internal oscillator frequency		-	180	-	MHz
Serial perip	oheral interface timing; pins CSB, S	CLK, SDI, and SDO				
t _{cy(clk)}	clock cycle time		250	-	-	ns
+	ODI sus abila la sal tima a		50			20
t _{SPILEAD}	SPI enable lead time		50	-	-	ns
t _{SPILEAD}	SPI enable lag time		50	-	-	ns
				- - -	-	
t _{SPILAG}	SPI enable lag time		50	- - -	- - -	ns
t _{SPILAG} t _{clk(H)}	SPI enable lag time clock HIGH time		50 125	- - - - -	- - - -	ns ns

Product data sheet

ASL1507SHN; ASL2507SHN

Single-phase and two-phase boost converter with limp-home mode

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{v(Q)}	data output valid time	pin SDO; C _L = 20 pF	-	-	130	ns
t _{WH(S)}	chip select pulse width HIGH		250	-	-	ns
Gate driver	characteristics for pin G1 and pin	G2				
t _{ch(G)}	gate charge time	20 % to 80 %; V_{VGG} = 7.5 V; C_L = 2000 pF	-	-	30	ns
t _{dch(G)}	gate discharge time	80 % to 20 %; V_{VGG} = 7.5 V; C_L = 2000 pF	-	-	14	ns
Regulated v	voltages					
t _{err(startup)}	start-up error time	VGG	-	2.5	-	ms
t _{det(err)}	error detection time	VGG after start-up	-	31.5	-	μs
t _{fltr(Vo)}	output voltage filter time	VO1_OK and VO2_OK	-	31.5	-	μs



Single-phase and two-phase boost converter with limp-home mode

13 Application information



Figure 19 provides an application example for the ASL2507SHN in a typical two-phase boost converter IC with one output voltage.

14 Test information

14.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q100 - *Failure mechanism-based stress test qualification for integrated circuits*, and is suitable for use in automotive applications.

Single-phase and two-phase boost converter with limp-home mode

15 Package outline



Figure 20. Package outline SOT617-12 (HVQFN32)

16 Revision history

Table 61. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
ASL1507_ASL2507 v.1	20180426	Product data sheet	-	-

17 Legal information

17.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

Please consult the most recently issued document before initiating or completing a design. [1]

The term 'short data sheet' is explained in section "Definitions".

[2] [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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ASL1507_ASL2507

Single-phase and two-phase boost converter with limp-home mode

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ASL1507SHN; ASL2507SHN

Single-phase and two-phase boost converter with limp-home mode

Tables

Tab. 1.	Ordering information
Tab. 2.	Pin description
Tab. 3.	Operating modes8
Tab. 4.	Operation mode register (address 56h) 8
Tab. 5.	SS scenario logic 1 (address 0Bh)11
Tab. 6.	SS scenario logic 2 (address 0Ch)11
Tab. 7.	Gate driver output (address 02h) 12
Tab. 8.	Gate driver phase (address 0Fh) 12
Tab. 9.	Phase select configuration (address 10h) 12
Tab. 10.	Gate driver enable (address 01h) 13
Tab. 11.	Clock divider for VO1 (address 09h)13
Tab. 12.	Clock divider for VO2 (address 0Ah)14
Tab. 13.	Phase-off time and phase delay of output 1
	(address 0Dh) 14
Tab. 14.	Phase-off time and phase delay of output 2
	(address 0Eh)14
Tab. 15.	Loop filter proportional configuration
	(address 11h)15
Tab. 16.	Loop filter integral configuration (address
	12h)
Tab. 17.	Slope compensation configuration (address
	13h)15
Tab. 18.	Current sense slope resistor configuration
	(address 14h)16
Tab. 19.	Output voltage 1 register (address 03h)16
Tab. 20.	Output voltage 2 register (address 04h)16
Tab. 21.	Limit voltage output 1 register (address 05h) 17
Tab. 22.	Limit voltage output 2 register (address 06h) 17
Tab. 23.	Ramp up output 1 (address 1Fh) 17
Tab. 24.	Ramp up output 2 (address 20h) 18
Tab. 25.	Internal register 5 (address 30h)18
Tab. 26.	Spread spectrum enable register (address
	1Ch)19
Tab. 27.	SS scenario logic 1 register (address 0Bh) 19
Tab. 28.	SS scenario logic 2 register (address 0Ch) 20
Tab. 29.	Ramp profile20
Tab. 30.	Random profile20
Tab. 31.	Maximum coil current VO1 register (address
	07h)21
Tab. 32.	Maximum coil current VO2 register (address
	08h)21

Tab. 33.	Function control register (address 00h)22
Tab. 34.	VGG control register (address 15h); bit 4 in
	NVM address 00h register is set to logic 0 22
Tab. 35.	VGG control register (address 15h); bit 4 in
140.00.	NVM address 00h register is set to logic 123
Tab. 36.	Battery voltage register (address 45h)
Tab. 37.	Undervoltage threshold register (address
T 1 00	1Bh)
Tab. 38.	Overvoltage threshold register (address
	1Ah)24
Tab. 39.	Junction temperature register (address 46h) 24
Tab. 40.	Diagnostic register (address 5Fh)25
Tab. 41.	Limp-home mode indication (address 54h) 27
Tab. 42.	Limp-home mode deactivation sequence28
Tab. 43.	Limp-home mode control register (address
	3Ch)
Tab. 44.	ECC code register (address 39h)29
Tab. 45.	NVM control register (address 3Ah)
Tab. 46.	NVM status register (address 55h)
Tab. 47.	Mapping of NVM registers to control
	registers
Tab. 48.	Overview of multi-content NVM data field 35
Tab. 49.	Comparison of limp-home mode and
140. 43.	autonomous mode
Tab. 50.	NVM programming options
Tab. 50. Tab. 51.	SPI frame format for a transition to the
Tab. 51.	device
Tab 50	
Tab. 52.	SPI frame format for a transition from the
	deviceThe first SPI command after leaving
	the off mode returns 00h
Tab. 53.	Control register group overview
Tab. 54.	Configuration register group overview43
Tab. 55.	Internal register overview44
Tab. 56.	Diagnostic register group overview
Tab. 57.	Limiting values 45
Tab. 58.	Thermal characteristics 45
Tab. 59.	Static characteristics 46
Tab. 60.	Dynamic characteristics 47
Tab. 61.	Revision history51

Figures

Fig. 10. Fig. 11.	Sequence to write into NVM registers	
Fig. 12.	Autonomous mode operation	
Fig. 13.	SPI timing protocol	
Fig. 14.	SPI frame format	38
Fig. 15.	Daisy chain configuration	39
Fig. 16.	Physical parallel slave connection	39
Fig. 17.	SPI frame format	40
Fig. 18.	SPI timing diagram	48
Fig. 19.	ASL2507SHN, configured as two-phase, single output boost converter	

ASL1507_ASL2507

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ASL1507SHN; ASL2507SHN

Single-phase and two-phase boost converter with limp-home mode

Fig. 20. Package outline SOT617-12 (HVQFN32)50

ASL1507SHN; ASL2507SHN

Single-phase and two-phase boost converter with limp-home mode

Contents

1	Introduction1
2	General description1
3	Features and benefits2
4	Applications2
5	Ordering information
6	Block diagram
7	Pinning information
7.1	Pinning
7.2	Pin description
8	Functional description7
8.1	Operating modes
8.1.1	Reset mode
8.1.2	
8.1.2	Configuration mode
	Standby mode
8.1.4	Operation mode9
8.1.5	Fail silent mode9
8.1.6	Limp-home mode9
8.1.7	NVM access mode9
8.2	Boost converter configuration10
8.2.1	Configuration of the virtual phases
8.2.2	Association of gate drivers to the output
	voltages11
8.2.3	Association of gate drivers to the internal
	phase generation12
8.2.4	Enabling of connected phases 12
8.2.5	Configuration of the boost converter
	frequencies
8.2.6	Control loop parameter setting
8.3	Output voltage programmability
8.3.1	Output voltage target programming
8.3.2	Output overvoltage protection programming 16
8.3.3	Output voltage ramp up
8.3.4	Dead-band setting
8.4	Frequency spread spectrum
8.5	Coil peak current limitation
8.6	Enabling the output voltage
8.7	
	Gate voltage supply
8.7.1	Gate voltage supply diagnostics
8.8	Supply voltage monitoring
8.8.1	Battery voltage measurement
8.8.2	Undervoltage detection
8.8.3	Overvoltage detection
8.9	Junction temperature information
8.10	Diagnostic information25
8.10.1	Bit VBAT_OV25
8.10.2	Bit VBAT_UV25
8.10.3	Bit SPI_ERR25
8.10.4	Bit TJ_ERR26
8.10.5	Bit VGG_ERR26
8.10.6	Bit VGG_OK
8.10.7	Bits VO1_OK and VO2_OK26
8.11	Restart on error26
8.12	Limp-home mode27

8.12.1	Limp-home mode activation	27
8.12.2	Limp-home mode operation	28
8.12.3	Limp-home mode deactivation	28
8.12.4	Limp-home mode control register	29
8.13	NVM memory	29
8.13.1	NVM write sequence	31
8.13.2	NVM read sequence	
8.13.3	NVM register map	35
8.14	Autonomous mode	36
8.14.1	Limp-home mode/autonomous mode NVM	36
8.15	SPI	
8.15.1	SPI introduction	37
8.15.2	Typical use case illustration (write/read)	40
8.15.3	Diagnostics for the SPI interface	40
8.15.4	Register map	41
8.15.4.1	e e la el legiere l	
8.15.4.2	Configuration registers	43
8.15.4.3		
8.15.4.4	Diagnostic registers	44
9	Limiting values	45
10	Thermal characteristics	45
11	Static characteristics	
12	Dynamic characteristics	
13	Application information	49
14	Test information	49
14.1	Quality information	
15	Package outline	
16	Revision history	
17	Legal information	52

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